

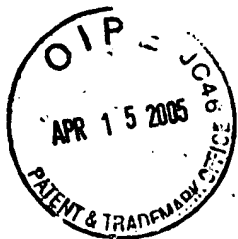


JFW

AMENDMENT TRANSMITTAL LETTER (Large Entity)				Docket No. 11948.26	
Applicant(s): Consuelo N. Tangpuz et al.					
Application No. 10/678,010	Filing Date October 2, 2003	Examiner T.T. Ho	Customer No. 27,966	Group Art Unit 2818	Confirmation No. 9241
Invention: METHOD FOR MAINTAINING SOLDER THICKNESS IN FLIPCHIP ATTACH PACKAGING PROCESSES <div style="border: 1px solid black; border-radius: 50%; padding: 5px; display: inline-block;">APR 15 2005 PATENT & TRADEMARK OFFICE</div>					
<u>COMMISSIONER FOR PATENTS:</u>					
Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.					
CLAIMS AS AMENDED					
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	25 -	39 =	0	x \$50.00	\$0.00
INDEP. CLAIMS	6 -	8 =	0	x \$200.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00
<div><input checked="" type="checkbox"/> No additional fee is required for amendment.</div> <div><input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of _____</div> <div><input type="checkbox"/> A check in the amount of _____ to cover the filing fee is enclosed.</div> <div><input checked="" type="checkbox"/> The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account 50-0843</div> <div><div><input checked="" type="checkbox"/> Any additional filing fees required under 37 C.F.R. 1.16.</div><div><input type="checkbox"/> Any patent application processing fees under 37 CFR 1.17.</div></div> <div><input type="checkbox"/> Payment by credit card. Form PTO-2038.</div>					
WARNING: Information on this form may become public. Credit card information should not be included on this form. Provide credit card information and authorization on PTO-2038.					
<div> _____ Signature</div> <div>Kenneth E. Horton, 39,481 Kirtan & McConkie P.O. Box 45120 Salt Lake City, UT 84145-0120 (801) 328-3600</div>			Dated: April 11, 2005		
cc:			<div style="border: 1px solid black; padding: 5px;"><div>I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on April 11, 2005 (Date)</div><div> _____ Signature of Person Mailing Correspondence</div><div>JoAnn Bawden Typed or Printed Name of Person Mailing Correspondence</div></div>		



Serial No. 10/678,010
Attorney Docket No. 11948.0026

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application:
Consuelo N. Tangpuz et al.

Serial No.: 10/678,010

Filed: October 2, 2003

For: METHOD FOR MAINTAINING
SOLDER THICKNESS IN FLIPCHIP
ATTACH PACKAGING PROCESSES

Confirmation No. 9241

Group Art Unit: 2818

Examiner: Ho, Tu-Tu

Mail Stop Non-Final Response
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

AMENDMENT AND REQUEST FOR RECONSIDERATION
UNDER 35 U.S.C. §§ 1.111 & 1.115

In response to the Office Action dated January 10, 2005, Applicant respectfully requests reconsideration of this application and in light of the following amendments and remarks.

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to:
Commissioner for Patents, P.O. Box 1450 Alexandria,
VA 22313-1450, on this 11th Day of April 2005.

Signed: _____

4/11/2005